

### Package Marking and Ordering Information

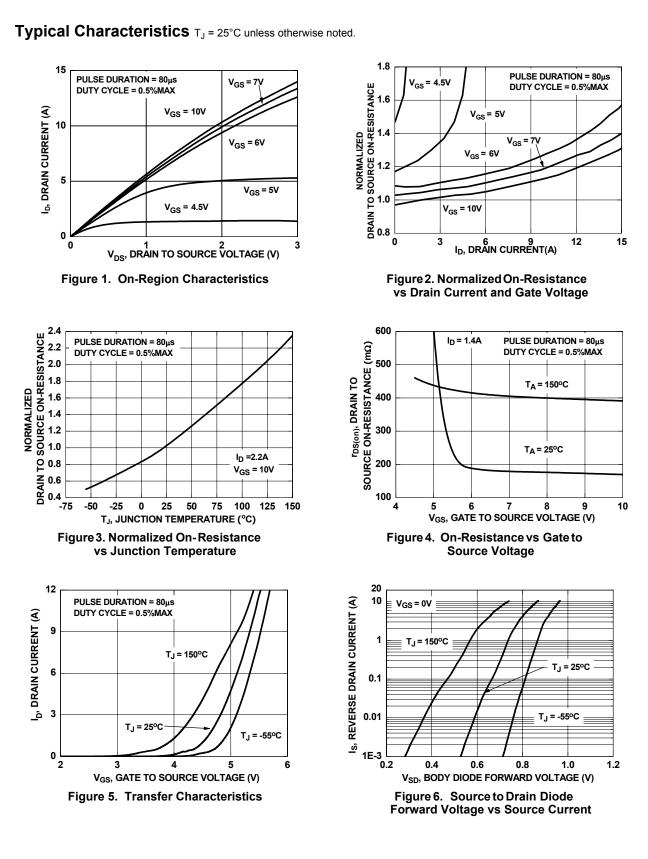
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC2610	FDMC2610	MLP 3.3x3.3	13 "	12 mm	3000 units

FDMC2610 N-Channel UltraFET Trench<sup>®</sup> MOSFET

teristics Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current teristics Gate to Source Threshold Voltage	$\begin{split} I_{D} &= 250 \mu A, \ V_{GS} = 0 V \\ I_{D} &= 250 \mu A, \ referenced \ to \ 25^{\circ}C \\ V_{DS} &= 160 V, \\ V_{GS} &= 0 V \\ V_{GS} &= 20 V, \ V_{DS} &= 0 V \\ \end{split}$	200	199	1 100	V mV/°C μA
Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current teristics	$I_D = 250\mu$ A, referenced to 25°C $V_{DS} = 160$ V, $V_{GS} = 0$ V $T_J = 125$ °C	200	199		mV/°C
Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current teristics	$I_D = 250\mu$ A, referenced to 25°C $V_{DS} = 160$ V, $V_{GS} = 0$ V $T_J = 125$ °C		199		
Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current teristics	$V_{DS} = 160V,$ $V_{GS} = 0V$ $T_{J} = 125^{\circ}C$		199		
Gate to Source Leakage Current	$V_{GS} = 0V$ $T_J = 125^{\circ}C$				μA
Gate to Source Leakage Current				100	per .
teristics	$V_{GS}$ = ±20V, $V_{DS}$ = 0V				
			1	±100	nA
Gate to Source Threshold Voltage					
Cale to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \mu A$	2	3.2	4	V
Gate to Source Threshold Voltage	$I_D = 250 \mu A$ , referenced to 25°C		-9.9		mV/°C
Temperature Coefficient					mv/ C
			175	200	
Drain to Source On Resistance			188	215	mΩ
				397	<u> </u>
Forward Transconductance	$V_{DS} = 5V, I_D = 2.2A$		7		S
haracteristics					
			720	960	pF
	$V_{\rm DS}$ = 100V, $V_{\rm GS}$ = 0V,		41	55	pF
	f = 1MHz		12	20	pF
Gate Resistance	f = 1MHz		0.7		Ω
,	$V_{pp} = 100 V_{lp} = 2.24$				ns
					ns
-			-		ns
					ns
				18	nC
Gate to Source Gate Charge	I <sub>D</sub> = 2.2A		3		nC
_			26		
Gate to Drain "Miller" Charge			3.6		nC
_			3.0		nc
Gate to Drain "Miller" Charge	V <sub>GS</sub> = 0V, I <sub>S</sub> = 2.2A (Note 2)		0.8	1.2	V
Gate to Drain "Miller" Charge	$V_{GS} = 0V, I_S = 2.2A$ (Note 2) $I_F = 2.2A, di/dt = 100A/\mu s$			1.2 104	I
	Drain to Source On Resistance Forward Transconductance haracteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V	Temperature CoefficientV GS = 10V, ID = 2.2ADrain to Source On Resistance $V_{GS} = 10V, ID = 2.2A$ $V_{GS} = 10V, ID = 2.2A, TJ = 125^{\circ}C$ Forward Transconductance $V_{DS} = 5V, ID = 2.2A$ haracteristicsInput CapacitanceOutput CapacitanceReverse Transfer CapacitanceGate ResistanceGate ResistanceTurn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate Charge at 10VVGS = 0V to 10VVDS = 100V to 10VVDD = 100VVDD = 100V	Temperature CoefficientV GS = 10V, ID = 2.2ADrain to Source On Resistance $V_{GS} = 10V, ID = 2.2A$ $V_{GS} = 10V, ID = 2.2A, TJ = 125^{\circ}C$ Forward Transconductance $V_{DS} = 5V, ID = 2.2A$ haracteristicsInput CapacitanceOutput CapacitanceReverse Transfer CapacitanceGate Resistancef = 1MHzCharacteristicsTurn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate Charge at 10VVGS = 0V to 10VVGS = 0V to 10VVDD = 100V, ID = 100VVDD = 100V	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

2: Pulse Test: Pulse Width < 300µs, Duty cycle < 2.0%.

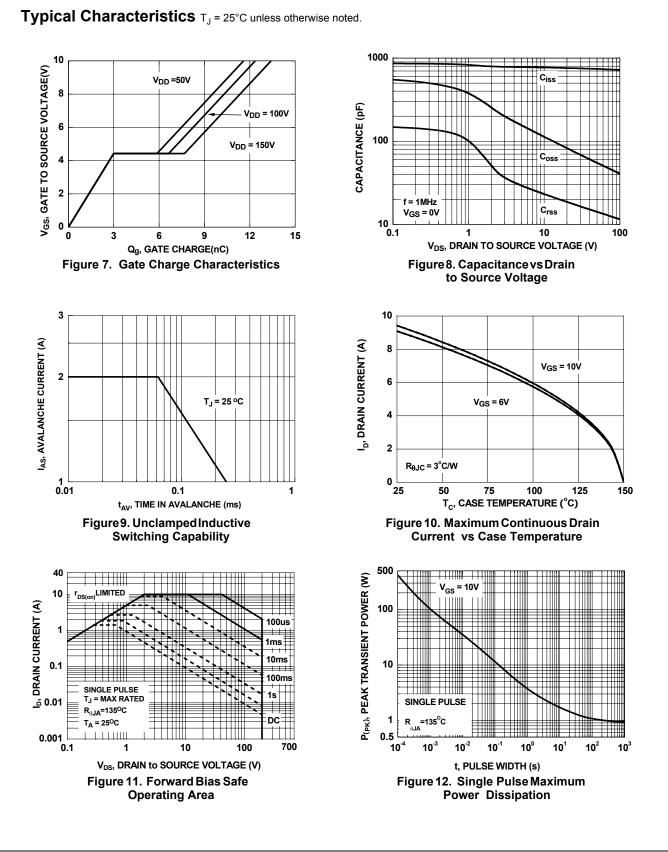
3. Starting  $T_J$  = 25 °C; N-ch: L = 3 mH,  $I_{AS}$  = 2 A,  $V_{DD}$  = 200 V,  $V_{GS}$  = 10 V.



FDMC2610 Rev.1.6

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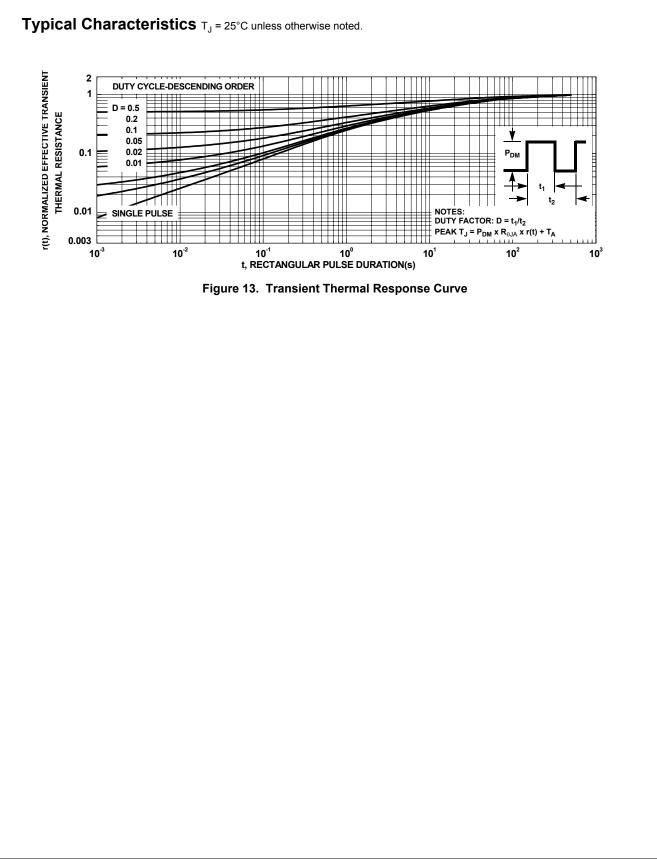


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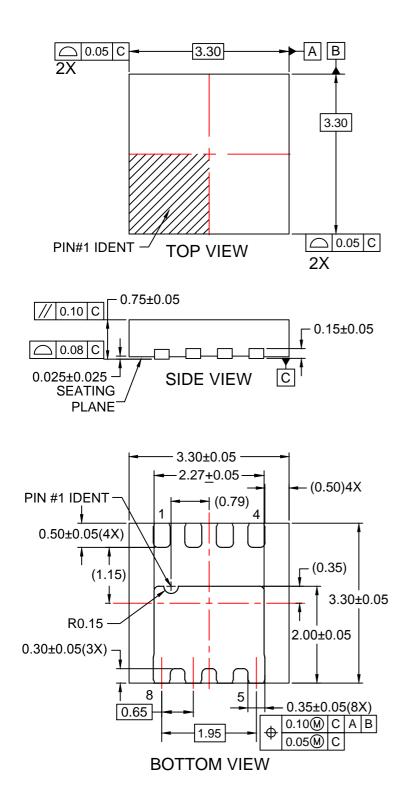
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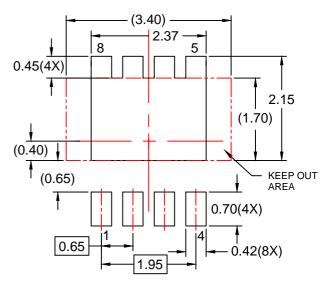
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FDMC2610 N-Channel UltraFET Trench<sup>®</sup> MOSFET



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## RECOMMENDED LAND PATTERN

NOTES:

- A. DOES NOT CONFORM TO JEDEC REGISTRATION MO-229
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-MLP08Srev3.





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Rev. 177

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